

03-14-2006



103196021

U.S. Department of Commerce
Patent and Trademark OfficeForm PTO-1595
6-93

OMB No. 0651-0011 (exp. 4/94)

To the Honorable Commissioner of Patents and Trademarks. Please record the attached

copy thereof.

1. Name of conveying party(ies):

Jain Seema

2. Name and address of receiving party(ies):

Name: Infineon Technologies AGStreet Address: St. Martin-Strasse 53City: 81669 MünchenCountry: GermanyAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ NoAdditional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Execution Date(s): 12/30/05

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is

A. Patent Application No(s)

B. Patent No(s)

Additional numbers attached? ☐ Yes ☒ NoTitle of Invention: Embedded Testing Circuit for Testing a Dual Port MemoryOur Docket No.: 1890-0333

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Harold C. MooreInternal Address: Maginot, Moore & BeckStreet Address: 111 Monument Circle, Suite 3250City: State: Zip: Indianapolis, IN 46204-5115

6. Total number of applications and patents involved

17. Total fee (37 CFR 3.41): \$. 40.00☒ Enclosed☐ Authorized to be charged to deposit account8. Deposit Account number: 13-0014

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Harold C. Moore

Name of Person Signing

Registration No. 37,892[Signature]
SignatureMarch 6, 2006

Date

Total number of pages including cover sheet, attachments and document 2Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services, Commissioner for Patents
P.O. Box 1450, Alexandria, VA 22313-1450

03/18/2006 MBELETE1 00000019 11291099

01 FC:0021

40.00 DP

PATENT
REEL: 017653 FRAME: 0138

INFINEON REF NO. S3765GC/Iko
MMB REF NO. 1890-0333

ASSIGNMENT

For good and valuable consideration, I, Jain Seema, a citizen of India, residing at C-113 Millenium Habitat, Kundalahalli, 550056 Bangalore, India, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, Serial No. 11/291,099, filed on 30 November 2005 and


entitled: **Embedded Testing Circuit for Testing a Dual Port Memory**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:


NAME: Jain Seema

DATE:

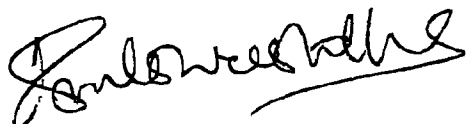
30/12/05

Witness 1 :


Mohan Narasimhan

Dec 30th, 2005

Witness 2 :


Karthi Kulasekaran

30.12.05